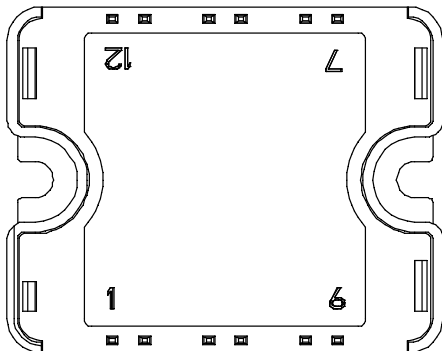
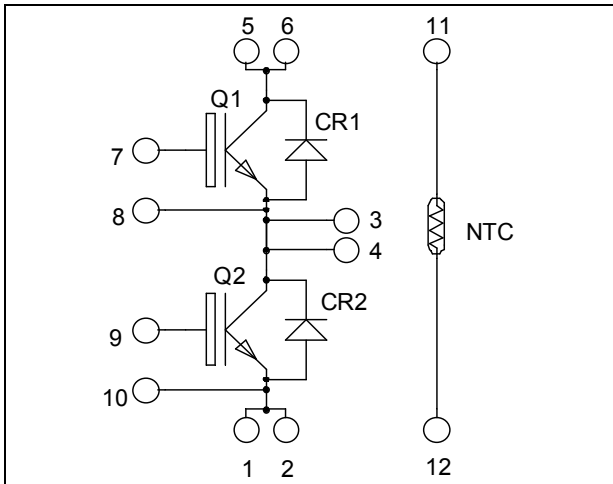


**Phase leg  
Fast Trench + Field Stop IGBT<sup>®</sup>  
Power Module**

**$V_{CES} = 1200V$   
 $I_C = 25A @ T_c = 80^\circ C$**



Pins 1/2 ; 3/4 ; 5/6 must be shorted together

### Application

- Welding converters
- Switched Mode Power Supplies
- Uninterruptible Power Supplies
- Motor control

### Features

- Fast Trench + Field Stop IGBT<sup>®</sup> Technology
  - Low voltage drop
  - Low tail current
  - Switching frequency up to 20 kHz
  - Soft recovery parallel diodes
  - Low diode VF
  - Low leakage current
  - RBSOA and SCSOA rated
- Very low stray inductance
  - Symmetrical design
- Internal thermistor for temperature monitoring
- High level of integration

### Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- RoHS Compliant

### Absolute maximum ratings

| Symbol    | Parameter                             | Max ratings         | Unit        |
|-----------|---------------------------------------|---------------------|-------------|
| $V_{CES}$ | Collector - Emitter Breakdown Voltage | 1200                | V           |
| $I_C$     | Continuous Collector Current          | $T_C = 25^\circ C$  | 40          |
|           |                                       | $T_C = 80^\circ C$  | 25          |
| $I_{CM}$  | Pulsed Collector Current              | $T_C = 25^\circ C$  | 50          |
| $V_{GE}$  | Gate - Emitter Voltage                | $\pm 20$            | V           |
| $P_D$     | Maximum Power Dissipation             | $T_C = 25^\circ C$  | 156         |
| RBSOA     | Reverse Bias Safe Operation Area      | $T_j = 125^\circ C$ | 50A @ 1150V |

**CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on [www.microsemi.com](http://www.microsemi.com)

All ratings @  $T_j = 25^\circ\text{C}$  unless otherwise specified

**Electrical Characteristics**

| Symbol        | Characteristic                       | Test Conditions                             | Min | Typ        | Max | Unit          |
|---------------|--------------------------------------|---|-----|------------|-----|---------------|
| $I_{CES}$     | Zero Gate Voltage Collector Current  | $V_{GE} = 0\text{V}, V_{CE} = 1200\text{V}$ |     |            | 250 | $\mu\text{A}$ |
| $V_{CE(sat)}$ | Collector Emitter Saturation Voltage | $V_{GE} = 15\text{V}$<br>$I_C = 25\text{A}$ |     | 1.7<br>2.0 | 2.1 | V             |
| $V_{GE(th)}$  | Gate Threshold Voltage               | $V_{GE} = V_{CE}, I_C = 1\text{mA}$         | 5.0 | 5.8        | 6.5 | V             |
| $I_{GES}$     | Gate – Emitter Leakage Current       | $V_{GE} = 20\text{V}, V_{CE} = 0\text{V}$   |     |            | 400 | nA            |

**Dynamic Characteristics**

| Symbol       | Characteristic               | Test Conditions  | Min   | Typ  | Max        | Unit |
|--------------|------------------------------|--|---|------|------------|------|
| $C_{ies}$    | Input Capacitance            | $V_{GE} = 0\text{V}, V_{CE} = 25\text{V}$  |   | 1800 |            | pF   |
| $C_{res}$    | Reverse Transfer Capacitance | $f = 1\text{MHz}$  |   | 82   |            |      |
| $T_{d(on)}$  | Turn-on Delay Time           | Inductive Switching ( $25^\circ\text{C}$ )<br>$V_{GE} = \pm 15\text{V}$<br>$V_{Bus} = 600\text{V}$<br>$I_C = 25\text{A}$<br>$R_G = 27\Omega$ |   | 90   |            | ns   |
| $T_r$        | Rise Time                    |  |   | 30   |            |      |
| $T_{d(off)}$ | Turn-off Delay Time          |  |   | 420  |            |      |
| $T_f$        | Fall Time                    |  |   | 70   |            |      |
| $T_{d(on)}$  | Turn-on Delay Time           |  | Inductive Switching ( $125^\circ\text{C}$ )<br>$V_{GE} = \pm 15\text{V}$<br>$V_{Bus} = 600\text{V}$<br>$I_C = 25\text{A}$<br>$R_G = 27\Omega$ |      | 90         |      |
| $T_r$        | Rise Time                    |  |   | 50   |            |      |
| $T_{d(off)}$ | Turn-off Delay Time          |  |   | 520  |            |      |
| $T_f$        | Fall Time                    |  |   | 90   |            |      |
| $E_{on}$     | Turn-on Switching Energy     | $V_{GE} = \pm 15\text{V}$<br>$V_{Bus} = 600\text{V}$   |   |      | 1.9<br>2.5 |      |
| $E_{off}$    | Turn-off Switching Energy    | $I_C = 25\text{A}$   |   | 1.9  |            |      |
|              |                              | $R_G = 27\Omega$   |   | 2.9  |            |      |

**Reverse diode ratings and characteristics**

| Symbol    | Characteristic                          | Test Conditions   | Min                       | Typ | Max | Unit          |   |
|-----------|---|---|---------------------------|-----|-----|---------------|---|
| $V_{RRM}$ | Maximum Peak Repetitive Reverse Voltage |   | 1200                      |     |     | V             |   |
| $I_{RM}$  | Maximum Reverse Leakage Current         | $V_R = 1200\text{V}$  | $T_j = 25^\circ\text{C}$  |     | 100 | $\mu\text{A}$ |   |
|           |   |   | $T_j = 125^\circ\text{C}$ |     | 500 |               |   |
| $I_F$     | DC Forward Current                      |   |                           | 25  |     | A             |   |
| $V_F$     | Diode Forward Voltage                   | $I_F = 25\text{A}$  | $T_j = 25^\circ\text{C}$  |     | 1.6 | 2.1           | V |
|           |   |   | $T_j = 125^\circ\text{C}$ |     | 1.6 |               |   |
| $t_{rr}$  | Reverse Recovery Time                   | $I_F = 25\text{A}$<br>$V_R = 600\text{V}$<br>$di/dt = 1500\text{A}/\mu\text{s}$ | $T_j = 25^\circ\text{C}$  |     | 160 | ns            |   |
|           |   |   | $T_j = 125^\circ\text{C}$ |     | 270 |               |   |
| $Q_{rr}$  | Reverse Recovery Charge                 |   | $T_j = 25^\circ\text{C}$  |     | 2.7 | $\mu\text{C}$ |   |
|           |   |   | $T_j = 125^\circ\text{C}$ |     | 4.8 |               |   |
| $E_r$     | Reverse Recovery Energy                 |   | $T_j = 25^\circ\text{C}$  |     | 1   | mJ            |   |
|           |   | $T_j = 125^\circ\text{C}$   |                           | 1.9 |     |               |   |

## Thermal and package characteristics

| Symbol            | Characteristic   | Min         | Typ | Max  | Unit |     |
|-------------------|--|-------------|-----|------|------|-----|
| R <sub>thJC</sub> | Junction to Case Thermal Resistance                                      | IGBT        |     | 0.80 | °C/W |     |
|                   |  | Diode       |     | 1.5  |      |     |
| V <sub>ISOL</sub> | RMS Isolation Voltage, any terminal to case t=1 min, I isol<1mA, 50/60Hz | 2500        |     |      | V    |     |
| T <sub>J</sub>    | Operating junction temperature range                                     | -40         |     | 150  | °C   |     |
| T <sub>STG</sub>  | Storage Temperature Range  | -40         |     | 125  |      |     |
| T <sub>C</sub>    | Operating Case Temperature   | -40         |     | 100  |      |     |
| Torque            | Mounting torque  | To heatsink | M4  | 2.5  | 4.7  | N.m |
| Wt                | Package Weight   |             |     |      | 80   | g   |

## Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

| Symbol             | Characteristic             | Min | Typ  | Max | Unit |
|--------------------|----------------------------|-----|------|-----|------|
| R <sub>25</sub>    | Resistance @ 25°C          |     | 50   |     | kΩ   |
| B <sub>25/85</sub> | T <sub>25</sub> = 298.15 K |     | 3952 |     | K    |

$$R_T = \frac{R_{25}}{\exp \left[ B_{25/85} \left( \frac{1}{T_{25}} - \frac{1}{T} \right) \right]}$$

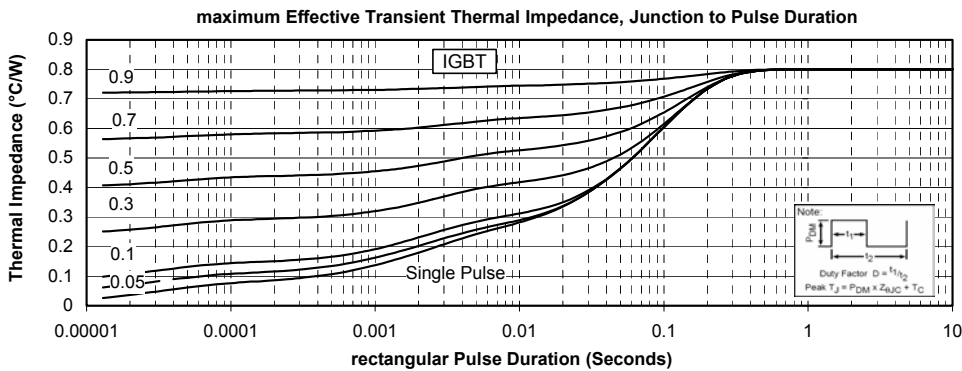
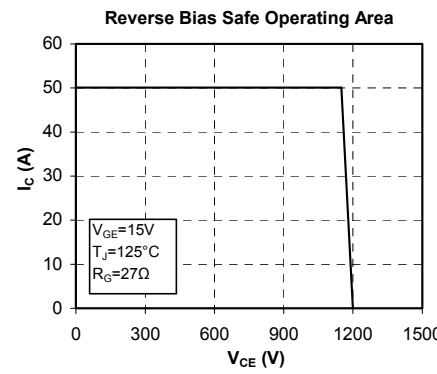
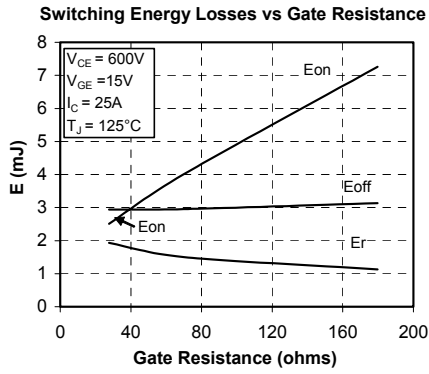
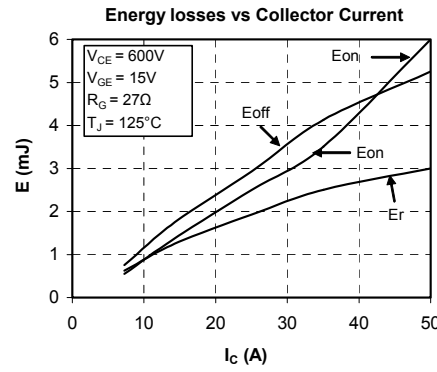
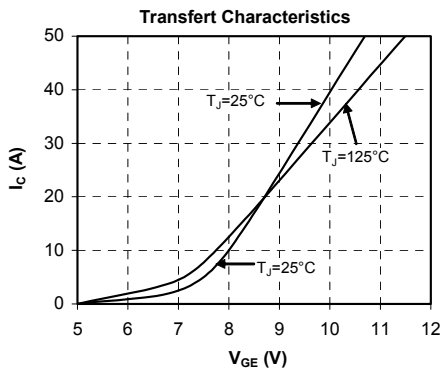
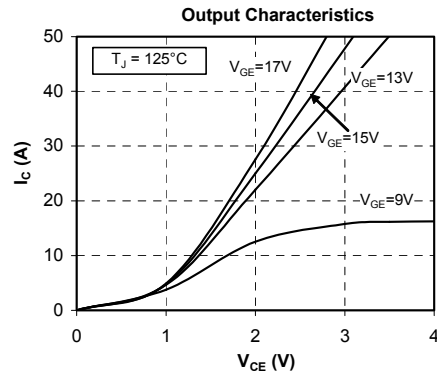
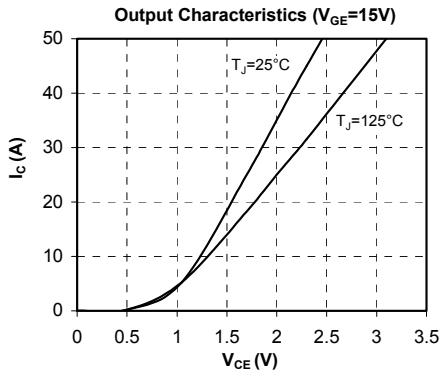
T: Thermistor temperature  
 R<sub>T</sub>: Thermistor value at T

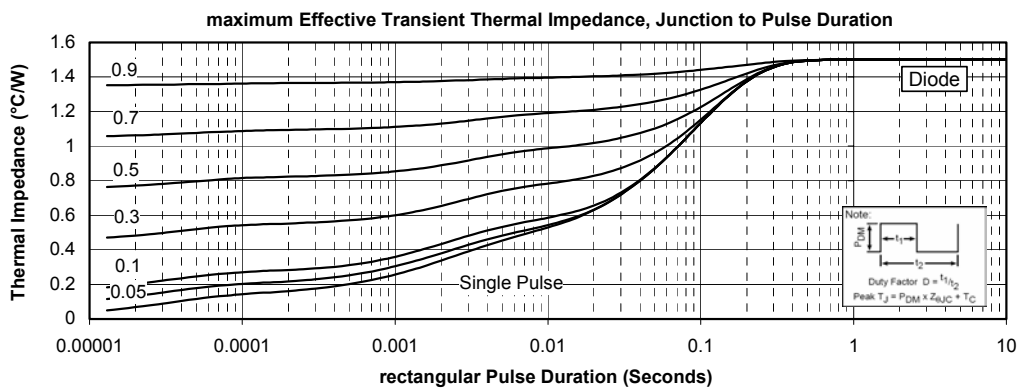
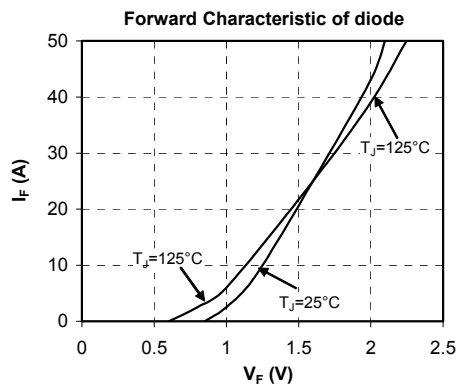
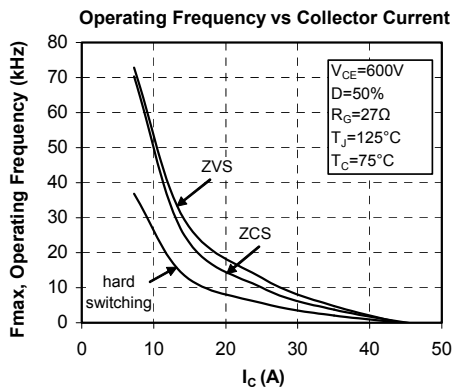
## SP1 Package outline (dimensions in mm)



See application note 1904 - Mounting Instructions for SP1 Power Modules on [www.microsemi.com](http://www.microsemi.com)

## Typical Performance Curve





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